

## EAST Search History

## EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	12205	(epi or epitax\$3) with layer with (trench or hole or via or open)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:11
S2	552	S1 with (diode or sensor or PD)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:12
S3	40	S2 with (conduct\$3 or contact or connect\$3) with (liner or barrier or fill)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:14
S4	53	S2 same (conduct\$3 or contact or connect\$3) with (liner or barrier or fill)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:19
S5	1178	S1 same (diode or sensor or PD)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:21
S6	131	S5 same (conduct\$3 or contact or connect\$3) same (liner or barrier or fill)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:21
S7	81	S6 and (@pd<"20031212" or @ad<"20031212" or @rlad<"20031212")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:23

S8	16746	(epi or epitax\$3) with (trench or hole or via or open)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:48
S9	360	S8 with (conduct\$3 or contact or connect\$3) with (liner or barrier or fill)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:49
S10	209	S9 and (@pd<"20031212" or @ad<"20031212" or @rlad<"20031212")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/03 12:49
S11	4	("6960483" "7217590").pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/04 09:40
S12	11	("4477835"   "5144747"   "5244817"   "5250843"   "5274250"   "5568574"   "6091194"   "6252220"   "6257491"   "6646289").PN. OR ("6960483"   "7217590").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2009/08/04 09:40
S13	7	pourquier-eric.in.	US-PGPUB; USPAT; USOCR	OR	ON	2009/08/04 09:41
S14	43838	(substrate or wafer) with (backside or back) with (contact or metal or conductor or connect\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/11 05:16
S15	8788	(substrate or wafer) with (backside or back) with (contact or metal or conductor or connect\$3) with (trench or hole or via or open)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/11 05:17
S16	863	(substrate or wafer) with (backside or back) with (contact or metal or conductor or connect\$3) with (trench or hole or via or open) with (polish\$3 or thin \$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/11 05:17

S17	358	S16 and @pd<"20031212"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/11 05:18
-----	-----	------------------------	---	----	----	---------------------

**8/ 13/ 2009 8:01:27 AM**

**C:\ Documents and Settings\ ejones1 \ My Documents\ EAST\ Workspaces  
 \ 10582711 AI MAGESENSOR.w sp**